

Features :

- Isolated mounting base 3000V~
- Pressure contact technology with Increased power cycling capability
- Space and weight saving

Typical Applications

- Various rectifiers
- DC supply for PWM inverter

V_{RSM}	V_{RRM}	品名
900V	800V	Mx250D80
1100V	1000V	Mx250D100
1300V	1200V	Mx250D120
1500V	1400V	Mx250D140
1700V	1600V	Mx250D160
1900V	1800V	Mx250D180

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T_j (°C)	VALUE			UNIT
				Min	Type	Max	
$I_{F(AV)}$	Mean forward current	180° half sine wave 50Hz Single side cooled, $T_c=100^\circ\text{C}$	150			250	A
$I_{F(RMS)}$	RMS forward current		150			393	A
I_{RRM}	Repetitive peak current	at V_{RRM}	150			20	mA
I_{FSM}	Surge forward current	10ms half sine wave $V_R=0.6V_{RRM}$	150			9.5	kA
I^2t	I^2t for fusing coordination					361	$\text{A}^2\text{s} \times 10^3$
V_{FO}	Threshold voltage		150			0.75	V
r_F	Forward slope resistance					0.76	mΩ
V_{FM}	Peak forward voltage	$I_{FM}=750\text{A}$	25			1.35	V
$R_{th(j-c)}$	Thermal resistance Junction to case	At 180° sine Single side cooled per chip				0.14	°C/W
$R_{th(c-h)}$	Thermal resistance case to heatsink	At 180° sine Single side cooled per chip				0.04	°C/W
V_{iso}	Isolation voltage	50Hz,R.M.S., $t=1\text{min}$, $I_{iso}=1\text{mA(max)}$		3000			V
F_m	Terminal connection torque(M8)				12.0		N·m
	Mounting torque(M6)				6.0		N·m
T_{vj}	Junction temperature			-40		150	°C
T_{stg}	Stored temperature			-40		125	°C
W_t	Weight				810		g
Outline		M03					

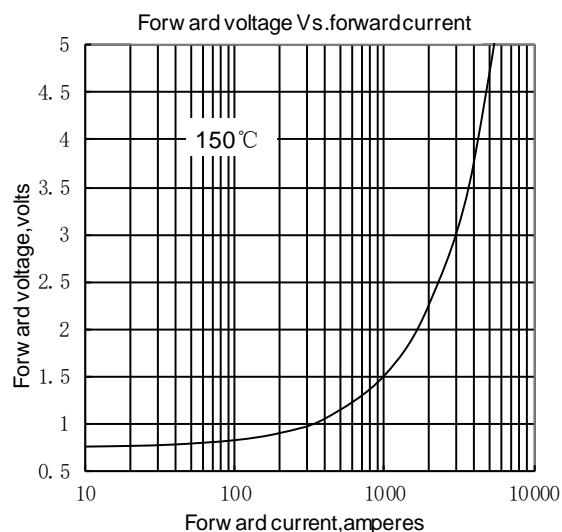


Fig.1

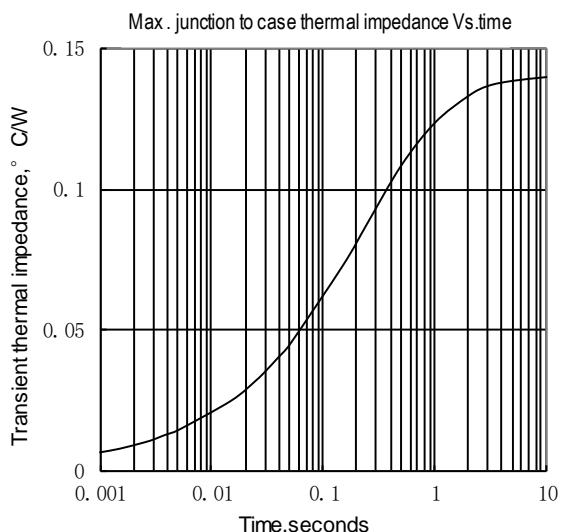


Fig.2

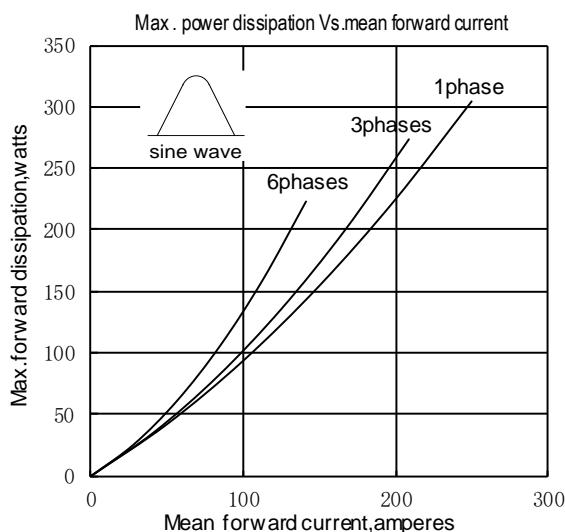


Fig.3

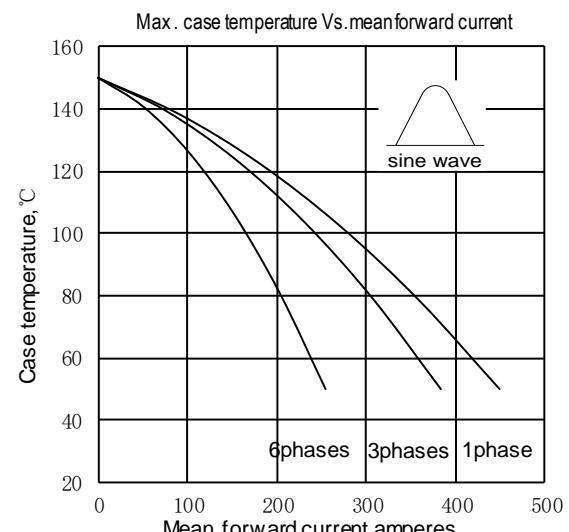


Fig.4

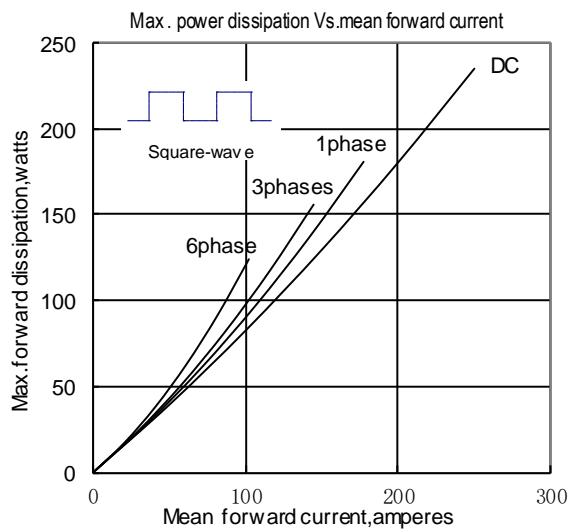


Fig.5

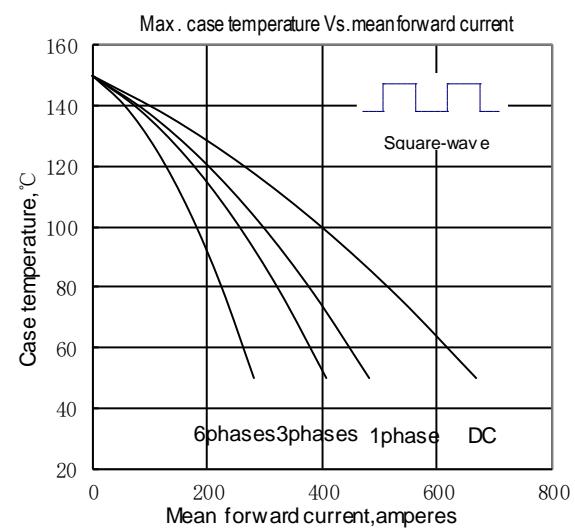


Fig.6

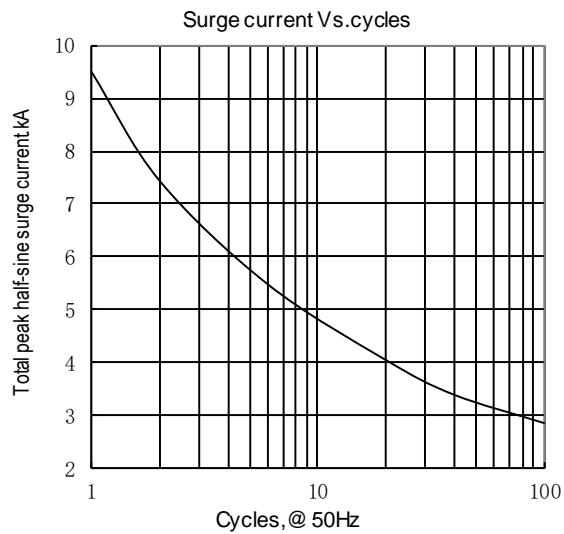


Fig.7

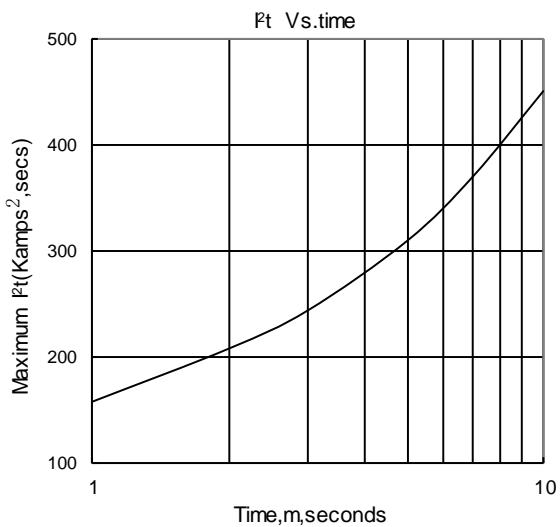
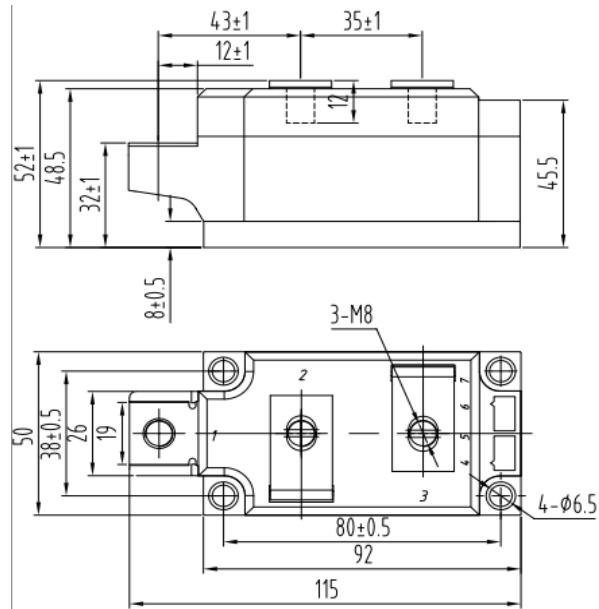
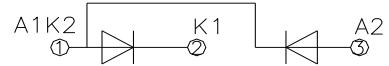


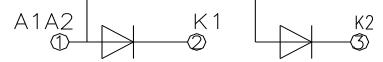
Fig.8



MD250D**



MR250D**



MC250D**

